ABSTRACT

The following document provides details on how to properly design a power monitor into a system. This document shows how to pull in various data sheet specifications to help a user design within the device’s capability. In addition to those specifications, this document strives to help a user understand the scaling limitations and the purpose of the various calculations and registers. Simultaneously, a basic routine will be defined for how to set up these registers.

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1 Introduction

There are several details that can easily be overlooked when designing with digital power monitors and overlooking these details can lead to errors and possibly late design changes. This document provides a structured design method that incorporates the key design specifications to be observed. In conjunction with this paper is a design tool that is built upon the method discussed in this paper. The method described in this paper follows the progression illustrated in the Figure 1-1.

Figure 1-1. Digital Power Monitor Design Flow Diagram
2 Defining Constraints

The first and most crucial step for designing with a digital power monitor is to define your system constraints for the device. These include the common mode voltage expected at the sense pins, the supply voltage you would like to use, the maximum current you want to measure, and the minimum current you want to measure. Common mode voltage and supply voltage are two specifications that can easily be extracted from the data sheet and used to narrow down your options. These specifications must be adhered to insure the device operates correctly and is not damaged. As for the current range the device can measure, the data sheet does not provide any bounds that can be simply looked up. The bounds are not only dependent on device specifications, but on design goals that include shunt power dissipation and resolution. The ensuing steps will provide details on how to assess a given device's current measurement bounds and determine if it will be adequate for your needs.

3 Find The Maximum Shunt Value

The shunt value ultimately determines the current measurement bounds. For a given current range, there may be a range of shunt resistance values that can be used allowing flexibility in your design. The maximum and minimum shunt values need to be calculated, to ensure you choose a shunt that will work for your application. To calculate the max shunt value, you need to look up the shunt voltage input range max listed in the electrical characteristics section of the data sheet. Some devices may have a fixed shunt voltage range as found in the Table 3-1, while others may have ranges that change according to certain register settings such as can be seen in the Table 3-2. One thing to note, is that some devices may have a different name for the shunt voltage input specification. Table 3-3 lists this specification as $V_{DIFF}$.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>INPUT</td>
<td>Shunt voltage input range</td>
<td>–81.9175</td>
<td>81.92 mV</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>INPUT</td>
<td>PGA = /1</td>
<td>0</td>
<td>±40</td>
<td>0</td>
<td>±40  mV</td>
</tr>
<tr>
<td></td>
<td>PGA = /2</td>
<td>0</td>
<td>±80</td>
<td>0</td>
<td>±80  mV</td>
</tr>
<tr>
<td></td>
<td>PGA = /4</td>
<td>0</td>
<td>±160</td>
<td>0</td>
<td>±160 mV</td>
</tr>
<tr>
<td></td>
<td>PGA = /8</td>
<td>0</td>
<td>±320</td>
<td>0</td>
<td>±320 mV</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>INPUT</td>
<td>$V_{DIFF}$</td>
<td>T$_{A}$=–40°C to +125°C, ADRANGE=0</td>
<td>-163.84</td>
<td>163.84 mV</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>T$_{A}$=–40°C to +125°C, ADRANGE=1</td>
<td>-40.96</td>
<td>40.96 mV</td>
<td></td>
</tr>
</tbody>
</table>

To find the $R_{SHUNT MAX}$ divide the max shunt input voltage value by your max expected current value.

$$R_{SHUNT MAX} \leq \frac{Shunt\ Voltage\ Input\ Range_{MAX}}{I_{Sense\ MAX}}$$ (1)
4 Find The Minimum Shunt Value

Upon calculating the max shunt value, the minimum shunt value should also be determined. To determine this value, you need to know the lowest meaningful shunt input voltage value. At minimum, this value corresponds to the shunt voltage register 1 LSB step size. There are some devices, like the INA209, INA219, and INA220 that for certain ADC configuration settings require a register bit higher than the LSB to be used, because the conversion time will not be sufficient to achieve the full possible resolution as alluded to in Table 4-1’s test conditions column. Be sure to check the Vsense register to gain better insight into what sense values are possible and how the data is stored. Below is the Table 4-2 for the INA228. Here we can see that the lowest resolvable shunt voltage neglecting noise corresponds to 312.5nV/LSB or 78.125nV/LSB depending on a ADCRANGE setting found in another register. Also we can see the register LSB does not correspond to the lowest ADC measurement LSB, which is important to be aware of when reading from the device.

Table 4-1. VSHUNT Register Field Descriptions

<table>
<thead>
<tr>
<th>Bit</th>
<th>Field</th>
<th>Type</th>
<th>Reset</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>23-4</td>
<td>VSHUNT</td>
<td>R</td>
<td>0h</td>
<td>Differential voltage measured across the shunt output. Two's complement value. Conversion factor: 312.5 nV/LSB when ADCRANGE = 0 78.125 nV/LSB when ADCRANGE = 1</td>
</tr>
<tr>
<td>3-0</td>
<td>RESERVED</td>
<td>R</td>
<td>0h</td>
<td>Reserved. Always reads 0.</td>
</tr>
</tbody>
</table>

To find the ideal $R_{SHUNT\ MIN}$ divide the shunt voltage 1 LSB step size by your minimum expected current value.

$$R_{SHUNT\ MIN} \geq \frac{\text{Shunt voltage 1 LSB step size}}{I_{Sense\ MIN}} \quad (2)$$

The LSB voltage corresponds the lowest measurable shunt value if error sources are neglected. The primary source of error for low current measurements is the input-referred offset voltage. This will vary with respect to common mode voltage, supply voltage, temperature, and device. As most power devices are bidirectional, you should be able to detect changes in your measured current even when the shunt voltage offset is larger than the shunt voltage LSB step size. Depending on your design, setup, and desired level of accuracy, you can calibrate this error out by taking an initial no load measurement at your common mode voltage and current conditions. If you have no intention of calibrating and are concerned about the percent error for your lower measurements, you can calculate $R_{SHUNT\ MIN}$ according to input referred offset voltage max and the percent error you can tolerate.

$$R_{SHUNT\ MIN} \geq \frac{V_{OS\ max}}{I_{Sense\ MIN} \times \frac{\text{error \ %\ allowed}}{100\%}} \quad (3)$$

The other significant source of error particularly noticeable at your lowest measurement is noise. Your device conversion and averaging setting will determine how significantly this impacts your measurement. As can be seen from the Figure 4-1, longer conversion times lead to measurements with much less noise. With typically the longest conversion time, averaging can also be used to further reduce variability from noise.
5 Maximum Resolution or Minimum Shunt Loss

Depending on how wide your current range is, you might have the option of optimizing your design for maximum resolution or for minimizing power dissipated across your shunt. The shunt resistor you choose will be the key factor for determining the resolution and shunt dissipation.

The calculated $R_{\text{SHUNT MAX}}$ is the value needed for maximum resolution assuming the calculated value is also larger than $R_{\text{SHUNT MIN}}$. The value calculated may not be a standard value and therefore unavailable from part distributors or even manufacturers. Consequently, you will need to adjust your value to match what can practically be done. To get the max desired current within your measurement range with max measurement resolution, you will need to choose a resistor value smaller than what you calculated, preferably the nearest, affordable, normally stocked option you can find.

For minimizing the power dissipation across the shunt, you simply need to use a resistor value smaller than $R_{\text{SHUNT MAX}}$. The exact value chosen will be dependent upon what error is allowed at the minimum sense current, where the error is dominated by the input offset voltage. If you are able to calibrate out the device input offset voltage and use one of the larger conversion settings you may be able to choose a shunt value at or close to $R_{\text{SHUNT MIN}}$. 

---

**Table 4-2. INA219 ADC Conversion Time table**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>INA219A</th>
<th></th>
<th>INA219B</th>
<th></th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>MIN</td>
<td>TYP</td>
<td>MAX</td>
<td>MIN</td>
<td>TYP</td>
</tr>
<tr>
<td>ADC timing</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ADC conversion time</td>
<td>12 bit</td>
<td>532</td>
<td>586</td>
<td>532</td>
<td>586</td>
<td>µs</td>
</tr>
<tr>
<td></td>
<td>11 bit</td>
<td>276</td>
<td>304</td>
<td>276</td>
<td>304</td>
<td>µs</td>
</tr>
<tr>
<td></td>
<td>10 bit</td>
<td>148</td>
<td>163</td>
<td>148</td>
<td>163</td>
<td>µs</td>
</tr>
<tr>
<td></td>
<td>9 bit</td>
<td>84</td>
<td>93</td>
<td>84</td>
<td>93</td>
<td>µs</td>
</tr>
</tbody>
</table>
What to Do if the Measurement Range Is Insufficient

In the event that not a single shunt can satisfy your design constraints, you may need to explore different options. The simplest option might be to use a different device. Devices with lower input offset voltage, with lower input bias current, and with more ADC bits of resolution, typically will allow you to measure a broader range of current. If these are still inadequate, you will need to get creative. One option would be to multiplex a parallel network of shunt resistors like in this Figure 6-1.

![Figure 6-1. Low-side Multiple Shunt Example](image)

Determine the Current LSB and Calibration Coefficient

The primary principle to understand is that all power monitors measure voltages. These voltages can then be used to calculate current and power provided the user knows the value of the shunt resistance being used. Voltage registers have fixed LSB values defined in the data sheet electrical characteristics section, whereas current and power registers have flexible LSBs based upon design criteria. The device needs the user tell it what those LSB values are. For convenience, we recommend scaling the LSB according the register bits and the max current you plan to measure. Consequently, we provide the Equation 4.

\[
\text{CURRENT_LSB} = \frac{\text{Max Expected Current}}{2^\left(\text{Valid Current Register Bits} - \text{Sign Bit}\right)}
\]  

Equation 4

Upon determining the current LSB, you can then determine the appropriate calibration coefficient. Depending on the device you will use an Equation 5 or an Equation 6. Refer to the device data sheet implementation section to determine which is appropriate.

\[
\text{CAL} = \frac{\text{Datasheet Coefficient}}{\text{CURRENT_LSB} \times R_{\text{SHUNT}}}
\]  

Equation 5

\[
\text{SHUNT_CAL} = \text{Datasheet Coefficient} \times \text{CURRENT_LSB} \times R_{\text{SHUNT}}
\]  

Equation 6
After calculating the coefficient, you need to verify that the value does not exceed the register size. The following equation will help you determine if the value satisfies that criteria. If you find your calibration coefficient to be too large, you have three options that include choosing a larger shunt, scaling the register to a higher maximum current than what is expected, or choosing a different device or ensemble of devices with greater measurement range.

$$\text{CAL or SHUNT_CAL} \leq 2^{\text{(Writeable Calibration Register Bits)}}$$  \hspace{1cm} (7)

Several calibration registers have 16 bits, yet not all of the bits may be writable for the user as can be seen from the Table 7-1.

### Table 7-1. Calibration Register (05h) (Read/Write) Description

<table>
<thead>
<tr>
<th>BIT #</th>
<th>D15</th>
<th>D14</th>
<th>D13</th>
<th>D12</th>
<th>D11</th>
<th>D10</th>
<th>D9</th>
<th>D8</th>
<th>D7</th>
<th>D6</th>
<th>D5</th>
<th>D4</th>
<th>D3</th>
<th>D2</th>
<th>D1</th>
<th>D0</th>
</tr>
</thead>
<tbody>
<tr>
<td>BIT NAME</td>
<td>—</td>
<td>FS14</td>
<td>FS13</td>
<td>FS12</td>
<td>FS11</td>
<td>FS10</td>
<td>FS9</td>
<td>FS8</td>
<td>FS7</td>
<td>FS6</td>
<td>FS5</td>
<td>FS4</td>
<td>FS3</td>
<td>FS2</td>
<td>FS1</td>
<td>FS0</td>
</tr>
<tr>
<td>POR VALUE</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td></td>
</tr>
</tbody>
</table>

One subtle nuance to recognize is that your CURRENT_LSB as well as several other values may be impossible to read from the device. The only values you can possibly read correspond to values that directly relate to the shunt voltage register. This issue can become quite noticeable if the difference between $R_{\text{SHUNT MAX}}$ and $R_{\text{SHUNT MIN}}$ is quite large and you proceed with a shunt value close to $R_{\text{SHUNT MIN}}$ to minimize power dissipation. In these cases, your current LSB will be significantly smaller than what can actually be resolved. To realize this, consider a simple high level example where the maximum shunt voltage is 80mV and the chosen shunt results in 40mV for the highest expected current, which you decide to program the calibration register to scale to. If the shunt voltage register has the same number of numerical bits as the current register, the CURRENT_LSB will be directly equivalent to half a shunt voltage LSB. As the current is actually calculated from the shunt voltage register, reading a single bit from the current register will not be attainable even if in reality the measurable current matches the CURRENT_LSB.

### 8 Programming Your Device Registers

Once the calibration value is determined, you can write that value to the calibration register. To ensure you read meaningful results, you will also likely need to program the configuration register(s) as the default settings might not be adequate for your design. As the configuration register(s) have ADC conversion settings, averaging settings, programmable gain settings, or some setting for selecting an ADC range, neglecting to program it can lead to significant deviations from expectation.

### 9 Summary

This application note shows a basic method for designing with a digital power monitor. Key specifications were discussed for determining shunt resistor range. Subsequently some insight was provided on how a shunt value can be tailored for resolution or power dissipation. After stressing the importance of the shunt, current range scaling was discussed along with programming registers.

### 10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision * (March 2021) to Revision A (September 2021)

- Deleted LM5056A Shunt Voltage Input Range table................................................................. 3
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